

N-Channel UltraFET Trench[®] MOSFET

Symbol Parameter Ratings Units Drain to Source Voltage 250 V V_{DS} Gate to Source Voltage ±20 V V_{GS} Drain Current -Continuous (Silicon limited) T_C = 25°C 14 T_A = 25°C -Continuous (Note 1a) 2.8 I_D А -Pulsed 30 Power Dissipation T_C = 25°C 78 PD W T_A = 25°C 2.5 **Power Dissipation** (Note 1a) Operating and Storage Junction Temperature Range -55 to +150 °C T_J, T_{STG}

General Description

UltraFET devices combine characteristics that enable benchmark efficiency in power conversion applications.

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Thermal Characteristics

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FDMS2734

Features

250V, 14A, 122mΩ

• Max $r_{DS(on)}$ = 122m Ω at V_{GS} = 10V, I_D = 2.8A

• Max $r_{DS(on)}$ = 130m Ω at V_{GS} = 6V, I_D = 1.7A

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.6	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS2734	DMS2734 FDMS2734 Power 56		13"	12mm	3000 units

March 2011

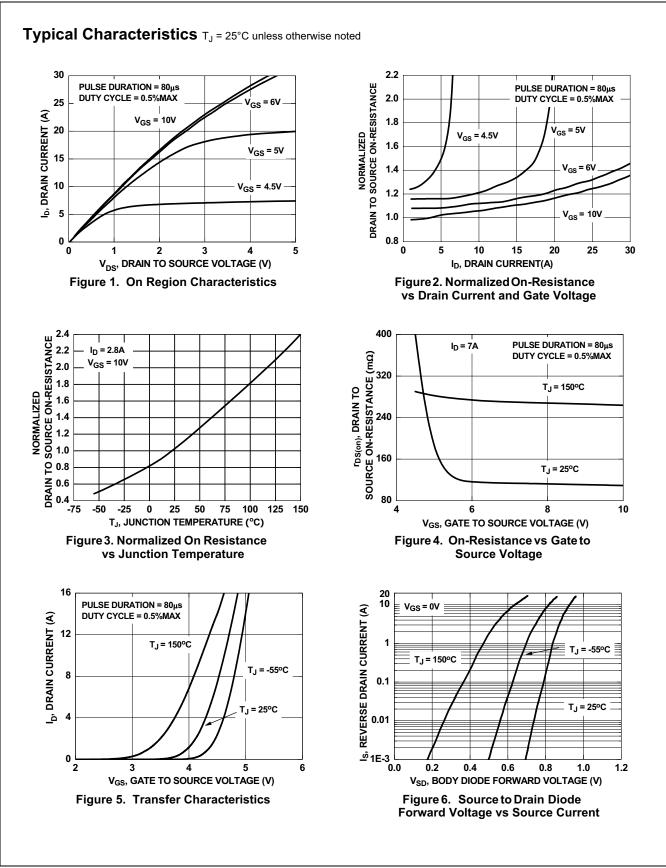
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FDMS2734
N-Channel U
UltraFET
Trench®
MOSFET

	Parameter	Test Conditions	Min	Тур	Max	Units
Uff Chara	cteristics	· · · ·				
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	250			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C	200	250		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200V,			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{GS} = 0V$			±100	nA
		00 00				
	cteristics (Note 2)	V _{GS} = V _{DS} , I _D = 250μA	2	3	4	V
V _{GS(th)}	Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$v_{GS} - v_{DS}$, $I_D - 250\mu A$	2	3	4	v
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-11		mV/°C
5		V _{GS} = 10V, I _D = 2.8A		105	122	mΩ
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 6V, I_D = 1.7A$		110	130	
		$V_{GS} = 10V, I_D = 2.8A T_J = 125^{\circ}C$		217	258	
9 _{FS}	Forward Transconductance	V _{DS} = 10V, I _D = 2.8A		11		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1775	2365	pF
C _{oss}	Output Capacitance			80	110	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		25	40	pF
	Gate Resistance	f = 1MHz			70	
	g Characteristics			0.9		Ω
R _g Switching t _{d(on)}	J Characteristics Turn-On Delay Time			22	36	Ω
Switching t _{d(on)} t _r	g Characteristics Turn-On Delay Time Rise Time	– V _{DD} = 125V, I _D = 2.8A		22 10	20	ns ns
Switching t _{d(on)} t _r t _{d(off)}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time			22 10 36	20 58	ns ns ns
Switching t _{d(on)} t _r t _{d(off)} t _f	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V _{DD} = 125V, I _D = 2.8A V _{GS} = 10V, R _{GEN} = 6Ω		22 10 36 12	20 58 22	ns ns ns ns
Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f $Q_{g(TOT)}$	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V	V_{DD} = 125V, I _D = 2.8A V_{GS} = 10V, R _{GEN} = 6Ω V_{GS} = 0V to 10V V_{DD} = 125V		22 10 36 12 30	20 58	ns ns ns ns nC
Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f $Q_{g(TOT)}$ Q_{gs}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge	V _{DD} = 125V, I _D = 2.8A V _{GS} = 10V, R _{GEN} = 6Ω		22 10 36 12 30 7	20 58 22	ns ns ns nC nC
Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f $Q_{g(TOT)}$	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V	V_{DD} = 125V, I _D = 2.8A V_{GS} = 10V, R _{GEN} = 6Ω V_{GS} = 0V to 10V V_{DD} = 125V		22 10 36 12 30	20 58 22	ns ns ns ns nC
Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f $Q_{g(TOT)}$ Q_{gs} Q_{gd}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge	V_{DD} = 125V, I _D = 2.8A V_{GS} = 10V, R _{GEN} = 6Ω V_{GS} = 0V to 10V V_{DD} = 125V		22 10 36 12 30 7	20 58 22	ns ns ns nC nC
Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f $Q_{g(TOT)}$ Q_{gs} Q_{gd} Drain-Sou	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge	V_{DD} = 125V, I _D = 2.8A V_{GS} = 10V, R _{GEN} = 6Ω V_{GS} = 0V to 10V V_{DD} = 125V		22 10 36 12 30 7	20 58 22	ns ns ns nC nC
Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f $Q_{g(TOT)}$ Q_{gs} Q_{gd}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{DD} = 125V, I_D = 2.8A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 125V$ $I_D = 2.8A$		22 10 36 12 30 7 9	20 58 22 42	ns ns ns nC nC nC

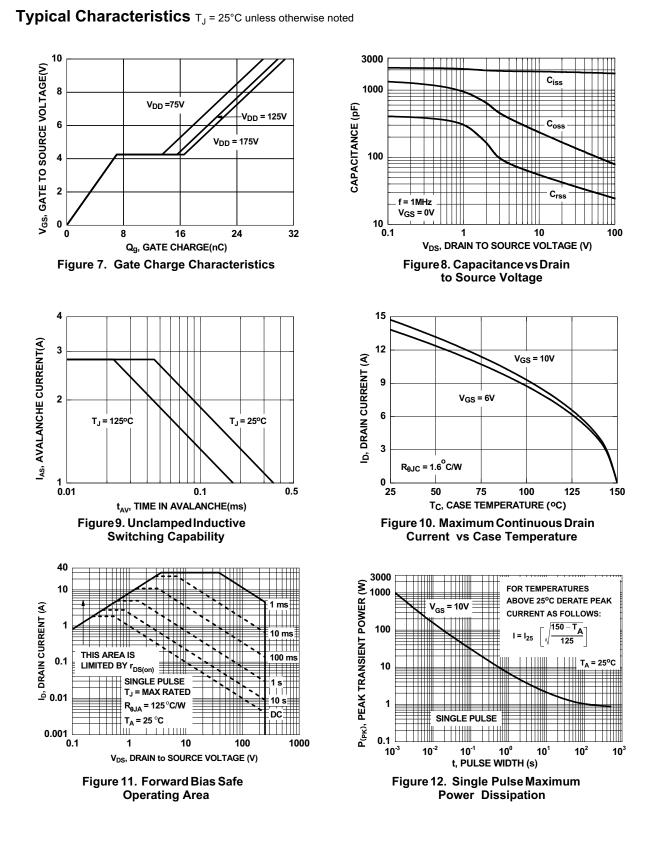
2: Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.



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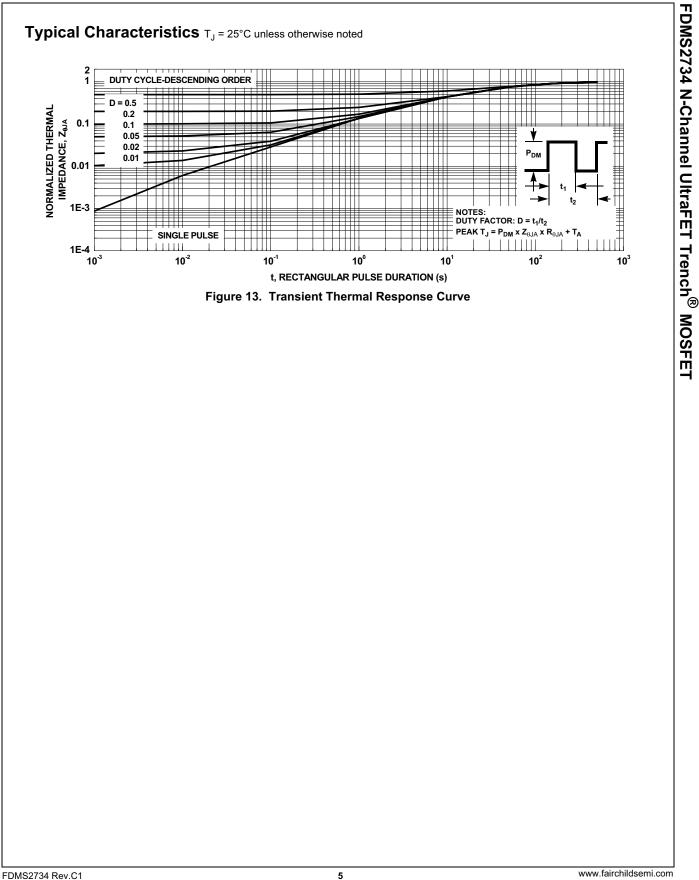
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0.10 C 5.0 A -0.77 Ð 8 4.52 6.0 6.61 4.32 3.91-0.10 C 4 2X PIN #1 IDENT -TOP VIEW 0.61 TYP. 1.27 TYP -0.8 MAX RECOMMENDED LAND PATTERN // 0.10 C (0.25) △ 0.08 C Ċ 0.05 SIDE VIEW SEATING PLANE 3.86 🛞 3.66 0.64 0.44 Э PIN #1 IDENT (OPTIONAL) 3.42 3.22 4.01? .10 5 1.27 0.36-0.46 🚯 ⊕ 0.10 C A B 3.81 (4) ⊕ 0.05∭ C BOTTOM VIEW NOTES: ODES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO-229. DATED 11/2001. B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994 D. TERMINALS 5,6,7 AND 8 ARE TIED TO THE EXPOSED PADDLE MLP08GrevD

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